DATASHEET

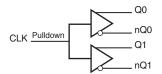
GENERAL DESCRIPTION

The 85222-02 is a 1-to-2 LVCMOS / LVTTL-to-Differential HSTL translator. The 85222-02 has one single ended clock input. The single-ended clock input accepts LVCMOS or LVTTL input levels and translates them to HSTL levels. The small outline 8-pin SOIC package makes this device ideal for applications where space, high performance and low power are important.

FEATURES

- Two differential HSTL outputs
- One LVCMOS/LVTTL clock input
- CLK input can accept the following input levels: LVCMOS or LVTTL
- Maximum output frequency: 350MHz
- Part-to-part skew: 250ps (maximum)
- Propagation delay: 1.25ns (maximum)
- V_:: 1.4V (maximum)
- Output crossover voltage: 0.68V 0.9V
- Full 3.3V operating supply voltage
- 0°C to 70°C ambient operating temperature
- Industrial temperature information available upon request
- Available in lead-free RoHS compliant package

BLOCK DIAGRAM



PIN ASSIGNMENT

| Q0 🗌 1 | 8 🗌 Vdd |
|---------|---------|
| nQ0 🗌 2 | 7 🗌 CLK |
| Q1 🗌 3 | 6 🗌 nc |
| nQ1 🗌 4 | 5 🗌 GND |

85222-02

8-Lead SOIC 3.90mm x 4.92mm x 1.37mm body package M Package Top View

TABLE 1. PIN DESCRIPTIONS

| Number | Name | Туре | | Description |
|--------|---------|--------|----------|--|
| 1, 2 | Q0, nQ0 | Output | | Differential output pair. HSTL interface levels. |
| 3, 4 | Q1, nQ1 | Output | | Differential output pair. HSTL interface levels. |
| 5 | GND | Power | | Power supply ground. |
| 6 | nc | Unused | | No connect. |
| 7 | CLK | Input | Pulldown | LVCMOS / LVTTL clock input. |
| 8 | V | Power | | Positive supply pin. |

NOTE: *Pulldown* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values. NOTE: Unused output pairs must be terminated.

TABLE 2. PIN CHARACTERISTICS

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|--------|-------------------------|-----------------|---------|---------|---------|-------|
| C | Input Capacitance | | | 4 | | pF |
| | Input Pulldown Resistor | | | 51 | | kΩ |

RENESAS

ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $V_{_{DD}}$ | 4.6V |
|---|--------------------------|
| Inputs, V | -0.5V to V_{DD} + 0.5V |
| Outputs, I Continuous Current Surge Current | 50mA 100mA |
| Package Thermal Impedance, θ_{A} | 112.7°C/W (0 lfpm) |
| Storage Temperature, T _{stg} | -65°C to 150°C |

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 3A. Power Supply DC Characteristics, $V_{_{DD}} = 3.3V \pm 5\%$, TA = 0°C to 70°C

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|--------|-------------------------|-----------------|---------|---------|---------|-------|
| V | Positive Supply Voltage | | 3.135 | 3.3 | 3.465 | V |
| | Power Supply Current | | | | 50 | mA |

TABLE 3B. LVCMOS / LVTTL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, TA = 0°C to 70°C

| Symbol | Parameter | | Test Conditions | Minimum | Typical | Maximum | Units |
|--------|--------------------|-----|-------------------------------------|---------|---------|-----------------------|-------|
| V | Input High Voltage | | | 2 | | V _{DD} + 0.3 | V |
| V | Input Low Voltage | | | -0.3 | | 0.8 | V |
| I. | Input High Current | CLK | $V_{_{DD}} = V_{_{IN}} = 3.465V$ | | | 150 | μA |
| I | Input Low Current | CLK | $V_{_{DD}} = 3.465, V_{_{IN}} = 0V$ | -5 | | | μA |

TABLE 3C. HSTL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, TA = 0°C to 70°C

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------------|-----------------------------------|-----------------|---------|---------|---------|-------|
| V _{oh} | Output High Voltage; NOTE 1 | | 1.0 | | 1.4 | V |
| V _{ol} | Output Low Voltage; NOTE 1 | | 0 | | 0.4 | V |
| V _{ox} | Output Crossover Voltage | | 0.68 | | 0.9 | V |
| V | Peak-to-Peak Output Voltage Swing | | 0.6 | 1.0 | 1.4 | V |

NOTE 1: All outputs must be terminated with 50Ω to ground.

TABLE 4. AC CHARACTERISTICS, $V_{DD} = 3.3V \pm 5\%$, TA = 0°C to 70°C

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|---------------------------------|---------------------------|-----------------|---------|---------|---------|-------|
| f _{_MAX} | Output Frequency | | | | 350 | MHz |
| t _{PD} | Propagation Delay; NOTE 1 | | 0.85 | 1.05 | 1.25 | ns |
| tsk(o) | Output Skew; NOTE 2, 3 | | | | 25 | ps |
| tsk(pp) | Part-to-Part Skew; NOTE 4 | | | | 250 | ps |
| t _B / t _F | Output Rise/Fall Time | 20% to 80% | 250 | | 500 | ps |
| | Outrout Duty Ovala | f ≤ 250MHz | 45 | | 55 | % |
| odc | Output Duty Cycle | f > 250MHz | 40 | | 60 | % |

All outputs must be terminated with 50W to ground.

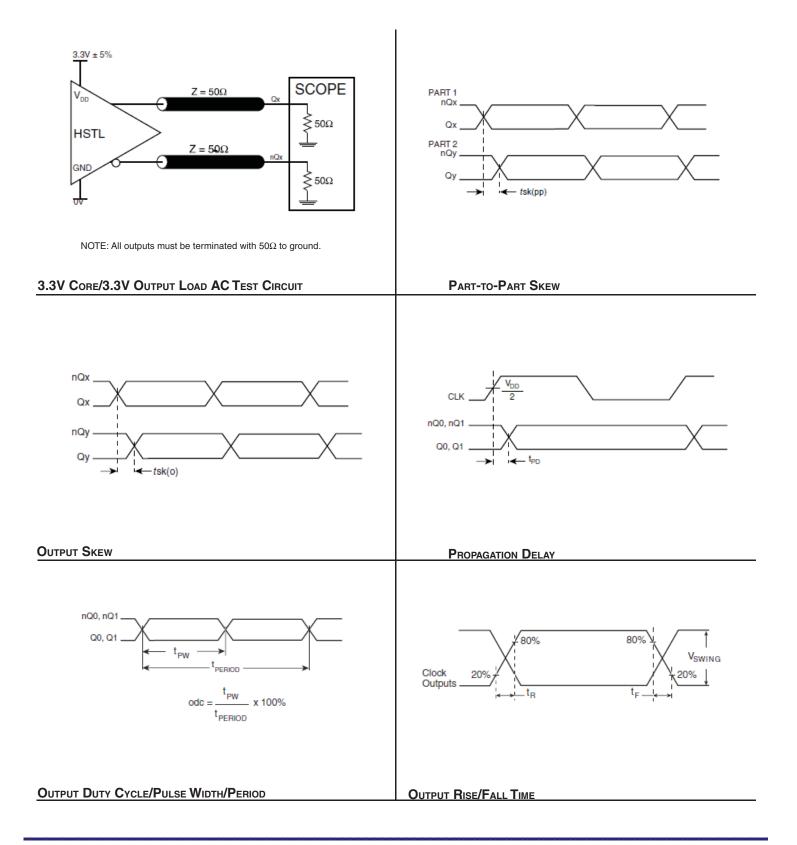
NOTE 1: Measured from $V_{po}/2$ of the input to the differential output crossing point.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.

NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 4: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at the differential cross points.





APPLICATION INFORMATION

RECOMMENDATIONS FOR UNUSED OUTPUT PINS

OUTPUTS:

HSTL OUTPUT All outputs must be terminated with 50 $\!\Omega$ to ground.

SCHEMATIC EXAMPLE

Figure 2 shows a schematic example of 85222-02. In the example, the input is driven by a 7 ohm LVCMOS driver with a series termination. The decoupling capacitor should be physically located

near the power pin. For 85222-02, the unused output need to be terminated.

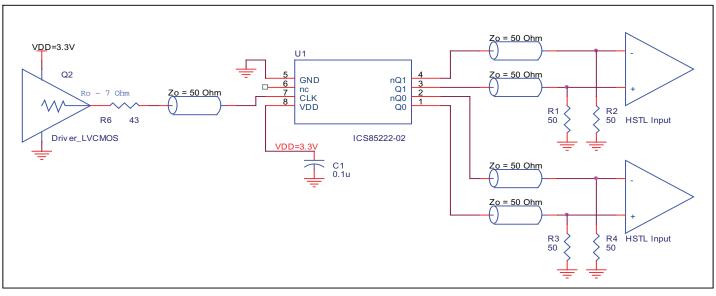


FIGURE 2. 85222-02 HSTL BUFFER SCHEMATIC EXAMPLE

Power Considerations

This section provides information on power dissipation and junction temperature for the 85222-02. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the 85222-02 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{DD} = 3.3V + 5\% = 3.465V$, which gives worst case results. **NOTE:** Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = V_{DD_MAX} * I_{DD_MAX} = 3.465V * 50mA = **173.25mW**
- Power (outputs)_{MAX} = 73.8mW/Loaded Output pair
 If all outputs are loaded, the total power is 2 * 82.3mW = 164.6mW

Total Power (3.465V, with all outputs switching) = 173.25mW + 164.6mW = 337.86mW

2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS[™] devices is 125°C.

The equation for Tj is as follows: Tj = $\theta_{JA} * Pd_total + T_A$

Tj = Junction Temperature

 θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total device power dissipation (example calculation is in Section 1 above)

T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{A} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 103.3°C/W per Table 5 below. Therefore, Tj for an ambient temperature of 70°C with all outputs switching is:

 $70^{\circ}C + 0.337W * 103.3^{\circ}C/W = 104.8^{\circ}C$. This is below the limit of $125^{\circ}C$.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

TABLE 5. THERMAL RESISTANCE θ_{JA} FOR 8-PIN SOIC, FORCED CONVECTION

| θ_{JA} by Velocity (Linear Feet per Minute) | | | | |
|---|-----------------------|-------------------------|-------------------------|--|
| Single Lover BCR JEDEC Standard Test Beards | 0 153.3°C/W | 200 128.5°C/W | 500 115.5°C/W | |
| Single-Layer PCB, JEDEC Standard Test Boards Multi-Layer PCB, JEDEC Standard Test Boards | 112.7°C/W | 128.5°C/W 103.3°C/W | 97.1°C/W | |

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.



3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

HSTL output driver circuit and termination are shown in Figure 1.

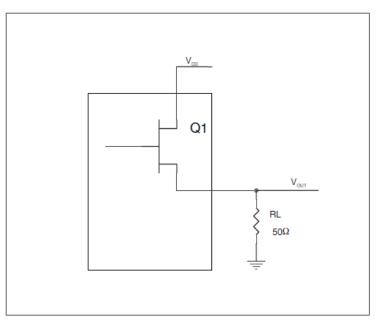


FIGURE 1. HSTL DRIVER CIRCUIT AND TERMINATION

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load.

Pd_H is power dissipation when the output drives high.

Pd_L is the power dissipation when the output drives low.

 $Pd_H = (V_{OH_MAX}/R_L) * (V_{DD_MAX} - V_{OH_MAX})$

 $Pd_L = (V_{\text{ol}_MAX}/R_{\text{l}}) * (V_{\text{dd}_MAX} - V_{\text{ol}_MAX})$

Total Power Dissipation per output pair = Pd_H + Pd_L = 82.3mW

RELIABILITY INFORMATION

TABLE 6. $\boldsymbol{\theta}_{_{\boldsymbol{J}\!\boldsymbol{A}}} \text{vs.}$ Air Flow Table 8 Lead SOIC

| θ_{JA} by Velocity (Linear Feet per Minute) | | | | | |
|--|-----------------------|-------------------------|-------------------------|--|--|
| Single-Layer PCB, JEDEC Standard Test Boards | 0 153.3°C/W | 200 128.5°C/W | 500 115.5°C/W | | |
| Multi-Layer PCB, JEDEC Standard Test Boards | 112.7°C/W | 103.3°C/W | 97.1°C/W | | |

TRANSISTOR COUNT

The transistor count for 85222-02 is: 411



PACKAGE OUTLINE - M SUFFIX FOR 8 LEAD SOIC

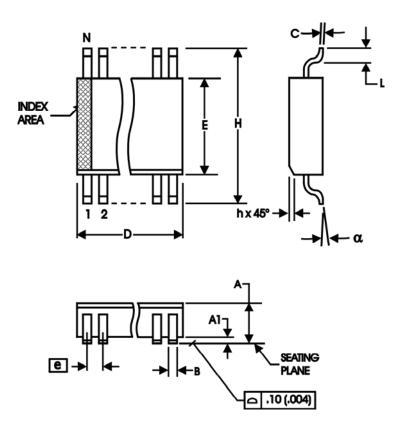


TABLE 7. PACKAGE DIMENSIONS

| CYMPOL | Millin | neters |
|--------|---------|---------|
| SYMBOL | MINIMUM | MAXIMUM |
| Ν | 8 | 8 |
| А | 1.35 | 1.75 |
| A1 | 0.10 | 0.25 |
| В | 0.33 | 0.51 |
| С | 0.19 | 0.25 |
| D | 4.80 | 5.00 |
| E | 3.80 | 4.00 |
| е | 1.27 8 | BASIC |
| Н | 5.80 | 6.20 |
| h | 0.25 | 0.50 |
| L | 0.40 | 1.27 |
| α | 0° | 8° |

Reference Document: JEDEC Publication 95, MS-012

TABLE 8. ORDERING INFORMATION

| Part/Order Number | Marking | Package | Shipping Package | Temperature |
|-------------------|----------|-------------------------|------------------|-------------|
| ICS85222AM-02LF | 5222A02L | 8 Lead "Lead-Free" SOIC | tube | 0°C to 70°C |
| ICS85222AM-02LFT | 5222A02L | 8 Lead "Lead-Free" SOIC | tape & reel | 0°C to 70°C |

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

| REVISION HISTORY SHEET | | | | |
|------------------------|-----------------|----------|---|---------|
| Rev | Table | Page | Description of Change | Date |
| A | | 5 6-7 | Added <i>Schematic Example.</i> Power Considerations - corrected power dissipation in calculations. | 7/24/06 |
| В | T1 T2 T3B | 2 2 | Updated Block Diagram with Pulldown for CLK. Pin Description - changed pin 7 as Pulldown instead of Pullup. Changed note to reflect Pulldown. Pin Characteristics - changed Pullup Resistor to Pulldown. LVCMOS DC Characteristics Table - changed I _µ from 5µA max. to 150µA max. and changed I _µ from -150µA min. to -5µA min. | 9/12/07 |
| В | Т8 | 10 1 | Ordering Information - removed leaded devices. Features Section - removed reference to leaded devices. Updated data sheet format. | 6/15/15 |



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